MA4FCP200



Flip Chip PIN Diode

Rev. V3

Features

- ♦ Low Series Resistance
- ◆ Low Capacitance
- ◆ Fast Switching Speed
- ♦ Silicon Nitride Passivation
- ◆ Polymer Scratch Protection
- ♦ RoHS Compliant

Description

M/A-COM Technology Solutions MA4FCP200 is a silicon flip chip PIN diode fabricated using a patented HMIC process which provides for repeatable electrical characteristics. This diode is fabricated on epitaxial wafers using a process designed for extremely low parasitics. The diode is fully passivated with silicon nitride to minimize leakage current. The chip also has an additional polymer layer for impact and scratch protection to prevent damage to the active area during handling.

Applications

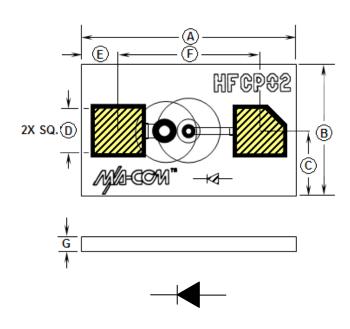
The small outline and low 0.05pS RC product, make the device useful in multi-throw switches and switched phase shifter circuits requiring <20nS switching speeds at operating frequencies up to 18GHz.

Absolute Maximum Ratings¹ T_{AMB} = +25°C (unless otherwise specified)

Parameter	Absolute Maximum		
Forward Current	100mA		
Reverse Voltage	- 70V		
Operating Temperature	- 55°C to + 125°C		
Storage Temperature	- 55°C to + 150°C		
Dissipated Power	100mW		
Mounting Temperature	+300°C for 10 seconds		

1. Exceeding any of these limits may cause permanent damage to the chip.

1264 Outline



- Backside metal contacts: 0.1µM thick gold.
- Yellow hatched areas indicate backside, mounting, ohmic, gold contacts.

D :	Inches		Millimeters		
Dim.	Min.	Max.	Min.	Max.	
А	0.014	0.015	0.356	0.381	
В	0.008	0.009	0.203	0.229	
С	0.004	0.005	0.102	0.127	
D	0.003	0.004	0.076	0.102	
Е	0.002	0.003	0.175	0.225	
F	0.008	0.010	0.203	0.254	
G	0.004	0.006	0.102	0.152	

ADVANCED: Data Sheets contain information regarding a product M/A-COM Technology Solutions is considering for development. Performance is based on target specifications, simulated results, and/or prototype measurements. Commitment to develop is not guaranteed.

PRELIMINARY: Data Sheets contain information regarding a product M/A-COM Technology Solutions has under development. Performance is based on engineering tests. Specifications are typical. Mechanical outline has been fixed. Engineering samples and/or test data may be available. Commitment to produce in volume is not quaranteed.

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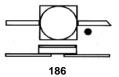


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Electrical Specifications @ T_{AMB} +25°C

Parameters @ Conditions	Symbol	Units	Min.	Тур.	Max.
Total Capacitance @ -40V, 1MHz ¹	Ст	pF		0.025	0.030
Total Capacitance @ -40V, 1GHz ^{1,3}	Ст	pF		0.020	
Series Resistance @ +50mA ^{2,3} , 100MHz	R _s	Ω		2.4	3.0
Series Resistance @ +50mA ^{2,3} , 1GHz	R _S	Ω		2.8	
Forward Voltage @ +100mA	V _F	V		1.25	1.5
Reverse Voltage @ -10μA	V_R	V	50		
Reverse Current @ -50V	I _R	μA			10
Lifetime @ $I_F = +10mA / I_{REV} = -6mA$	T_L	nS		100	
Steady State Thermal Resistance ⁴	θ	°C/W		900	

- 1. Total capacitance is equivalent to the sum of junction capacitance, Cj, plus the die parasitic capacitance, Cp.
- The series resistance, R_S, is equal to the total diode resistance which also includes the resistance of the junction, Rj.
- 3. Rs and Cp measured on an HP4291A with die mounted in an ODS-186 package.
- 4. Steady-state Thermal Resistance measured with die mounted in an ODS-186 package.



ESD

These devices very susceptible to ESD and are rated Class 0 (0-199V) per HBM MIL-STD-883, method 3015.7 [C = 100pF \pm 10%, R = 1.5kW \pm 1%]. Even though tested die pass 100V ESD, they must be handled in a static-free environment.

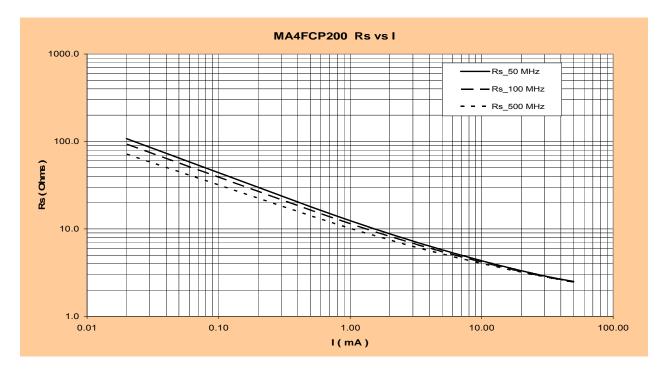
Specifications Subject to Change Without Notice.

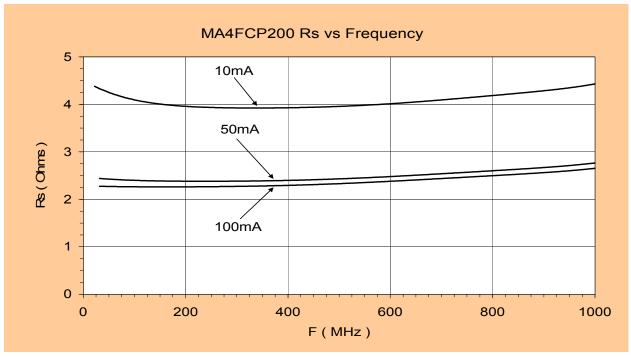
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Typical Performance @ T_{AMB} +25°C





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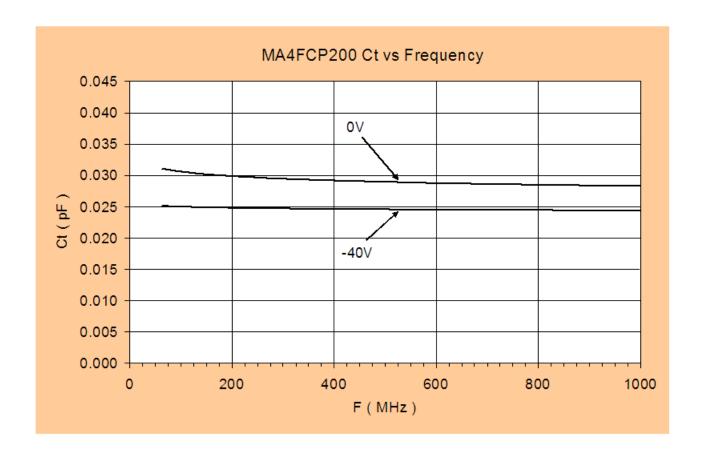
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MA4FCP200 SPICE Model

PinDiodeModel

NLPINM1

Is=1.0E-14 A wBv = 70 V

Vi=0.0 V wPmax= 100 mW

Un= 900 cm^2/V-sec Ffe= 1.0

Wi= 5.0 um

Rr= 10 K Ohms

Cimin= 0.02 pF

Tau= 0.10 usec

Rs(I) = Rc + Ri(I) = 0.05 Ohm + Ri(I)

 $C_{i0} = 0.03 pF$

 $V_{j} = 0.7 V$

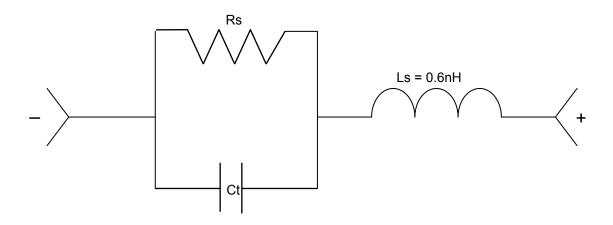
M = 0.5

Fc = 0.5

Imax= 1.0 E+5 A/m^2

Kf=0.0

Af = 1.0



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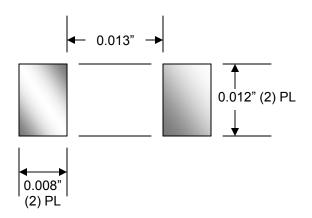
Handling Procedures

All semiconductor chips should be handled with care to avoid damage or contamination from perspiration and skin oils. The use of plastic tipped tweezers or vacuum pickups is strongly recommended for individual components. Bulk handling should insure that abrasion and mechanical shock are minimized.

Bonding Techniques

These devices were designed for insertion onto hard or soft substrates with the junction side down. They can be mounted with electrically conductive epoxy or with a eutectic solder preform. However, tin rich solders will scavenge gold from the bottom contacts and are not recommended. Indalloy or 80/20, Au/Sn, solders are acceptable. Maximum soldering temperature must be <300°C for <10 sec. These chips are designed to be inserted onto hard or soft substrates with the junction side down. They should be mounted onto silkscreened circuits using electrically conductive Ag epoxy, approximately 1-2 mils in thickness and cured at approximately 90°C to 150°C per manufacturer's schedule. For extended cure times, >30 minutes, temperatures must be kept below 200°C. The die can also be assembled using non conductive epoxy with the junction side up, and wire or ribbon bonds made to the pads.

Circuit Mounting Dimensions (Inches)



Ordering Information

Part Number	Packaging
MA4FCP200	Die in Gel Pack
MA4FCP200-W	Wafer Cut on Tape

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